

FOD814 Series, FOD617 Series, FOD817 Series 4-Pin High Operating Temperature Phototransistor Optocouplers

Features

- AC input response (FOD814 only)
- Applicable to Pb-free IR reflow soldering
- Compact 4-pin package
- Current transfer ratio in selected groups:

FOD617A: 40–80%	FOD817: 50–600%
FOD617B: 63–125%	FOD817A: 80–160%
FOD617C: 100–200%	FOD817B: 130–260%
FOD617D: 160–320%	FOD817C: 200–400%
FOD814: 20–300%	FOD817D: 300–600%
FOD814A: 50–150%	
- C-UL, UL and VDE approved
- High input-output isolation voltage of 5000Vrms
- Minimum BV_{CEO} of 70V guaranteed
- Higher operating temperatures (versus H11AXXX counterparts)

Applications

FOD814 Series

- AC line monitor
- Unknown polarity DC sensor
- Telephone line interface

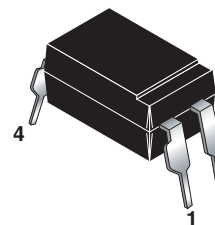
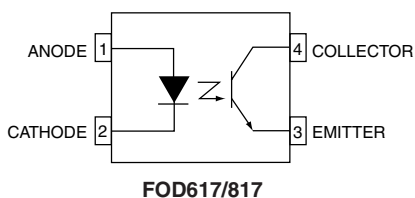
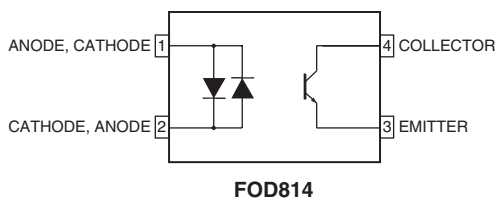
FOD617 and FOD817 Series

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

Description

The FOD814 consists of two gallium arsenide infrared emitting diodes, connected in inverse parallel, driving a silicon phototransistor output in a 4-pin dual in-line package. The FOD617/817 Series consists of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 4-pin dual in-line package.

Functional Block Diagram



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Symbol	Parameter	Value		Units
		FOD814	FOD617/817	
TOTAL DEVICE				
T_{STG}	Storage Temperature	-55 to +150		$^\circ\text{C}$
T_{OPR}	Operating Temperature	-55 to +105	-55 to +110	$^\circ\text{C}$
T_{SOL}	Lead Solder Temperature	260 for 10 sec		$^\circ\text{C}$
P_{TOT}	Total Power Dissipation	200		mW
EMITTER				
I_F	Continuous Forward Current	± 50	50	mA
V_R	Reverse Voltage	-	6	
P_D	Power Dissipation	70		mW
	Derate above 100°C	1.7		$\text{mW}/^\circ\text{C}$
DETECTOR				
V_{CEO}	Collector-Emitter Voltage	70		V
V_{ECO}	Emitter-Collector Voltage	6	6 (FOD817) 7 (FOD617)	V
I_C	Continuous Collector Current	50		mA
P_C	Collector Power Dissipation	150		mW
	Derate above 90°C	2.9		$\text{mW}/^\circ\text{C}$

Electrical Characteristics ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Individual Component Characteristics

Symbol	Parameter	Device	Test Conditions	Min.	Typ.*	Max.	Unit
EMITTER							
V_F	Forward Voltage	FOD814	$I_F = \pm 20\text{mA}$	–	1.2	1.4	V
		FOD617	$I_F = 60\text{mA}$	–	1.35	1.65	
		FOD817	$I_F = 20\text{mA}$	–	1.2	1.4	
I_R	Reverse Leakage Current	FOD617	$V_R = 6.0\text{V}$	–	0.001	10	μA
		FOD817	$V_R = 4.0\text{V}$	–	–	10	
C_t	Terminal Capacitance	FOD814	$V = 0, f = 1\text{kHz}$	–	50	250	pF
		FOD617	$V = 0, f = 1\text{kHz}$	–	30	250	
		FOD817	$V = 0, f = 1\text{kHz}$	–	30	250	
DETECTOR							
I_{CEO}	Collector Dark Current	FOD814	$V_{CE} = 20\text{V}, I_F = 0$	–	–	100	nA
		FOD617C/D	$V_{CE} = 10\text{V}, I_F = 0$	–	1	100	
		FOD617A/B	$V_{CE} = 10\text{V}, I_F = 0$	–	1	50	
		FOD817	$V_{CE} = 20\text{V}, I_F = 0$	–	–	100	
BV_{CEO}	Collector-Emitter Breakdown Voltage	FOD814	$I_C = 0.1\text{mA}, I_F = 0$	70	–	–	V
		FOD617	$I_C = 100\mu\text{A}, I_F = 0$	70	–	–	
		FOD817	$I_C = 0.1\text{mA}, I_F = 0$	70	–	–	
BV_{ECO}	Emitter-Collector Breakdown Voltage	FOD814	$I_E = 10\mu\text{A}, I_F = 0$	6	–	–	V
		FOD617	$I_E = 10\mu\text{A}, I_F = 0$	7	–	–	
		FOD817	$I_E = 10\mu\text{A}, I_F = 0$	6	–	–	

Transfer Characteristics ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Symbol	DC Characteristic	Device	Test Conditions	Min.	Typ.*	Max.	Unit
CTR	Current Transfer Ratio	FOD814	$I_F = \pm 1\text{mA}, V_{CE} = 5\text{V}^{(1)}$	20	–	300	%
		FOD814A		50	–	150	
		FOD617A	$I_F = 10\text{mA}, V_{CE} = 5\text{V}^{(1)}$	40	–	80	
		FOD617B		63	–	125	
		FOD617C		100	–	200	
		FOD617D		160	–	320	
		FOD617A	$I_F = 1\text{mA}, V_{CE} = 5\text{V}^{(1)}$	13	–	–	
		FOD617B		22	–	–	
		FOD617C		34	–	–	
		FOD617D		56	–	–	
		FOD817	$I_F = 5\text{mA}, V_{CE} = 5\text{V}^{(1)}$	50	–	600	
		FOD817A		80	–	160	
		FOD817B		130	–	260	
		FOD817C		200	–	400	
FOD817D	300	–		600			
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	FOD814	$I_F = \pm 20\text{mA}, I_C = 1\text{mA}$	–	0.1	0.2	V
		FOD617	$I_F = 10\text{mA}, I_C = 2.5\text{mA}$	–	–	0.4	
		FOD817	$I_F = 20\text{mA}, I_C = 1\text{mA}$	–	0.1	0.2	

*Typical values at $T_A = 25^\circ\text{C}$

Transfer Characteristics (Continued) ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Symbol	AC Characteristic	Device	Test Conditions	Min.	Typ.*	Max.	Unit
f_C	Cut-Off Frequency	FOD814	$V_{CE} = 5\text{V}$, $I_C = 2\text{mA}$, $R_L = 100\Omega$, -3dB	15	80	–	kHz
t_r	Response Time (Rise)	FOD814	$V_{CE} = 2\text{V}$, $I_C = 2\text{mA}$, $R_L = 100\Omega^{(2)}$	–	4	18	μs
		FOD617					
		FOD817					
t_f	Response Time (Fall)	FOD814		–	3	18	μs
		FOD617					
		FOD817					

Isolation Characteristics

Symbol	Characteristic	Device	Test Conditions	Min.	Typ.*	Max.	Units
V_{ISO}	Input-Output Isolation Voltage ⁽³⁾	FOD814	$f = 60\text{Hz}$, $t = 1\text{ min}$, $I_{I-O} \leq 2\mu\text{A}$	5000			Vac(rms)
		FOD617					
		FOD817					
R_{ISO}	Isolation Resistance	FOD814	$V_{I-O} = 500\text{VDC}$	5×10^{10}	1×10^{11}	–	Ω
		FOD617					
		FOD817					
C_{ISO}	Isolation Capacitance	FOD814	$V_{I-O} = 0$, $f = 1\text{ MHz}$		0.6	1.0	pf
		FOD617					
		FOD817					

*Typical values at $T_A = 25^\circ\text{C}$

Notes:

1. Current Transfer Ratio (CTR) = $I_C/I_F \times 100\%$.
2. For test circuit setup and waveforms, refer to page 4.
3. For this test, Pins 1 and 2 are common, and Pins 3 and 4 are common.

Typical Electrical/Optical Characteristics ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Fig. 1 Collector Power Dissipation vs. Ambient Temperature (FOD814)

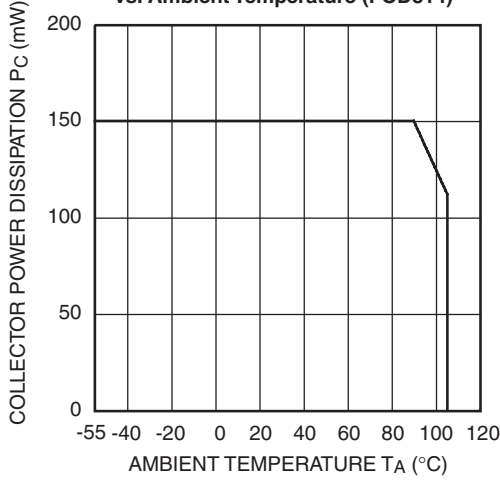


Fig. 2 Collector Power Dissipation vs. Ambient Temperature (FOD617/817)

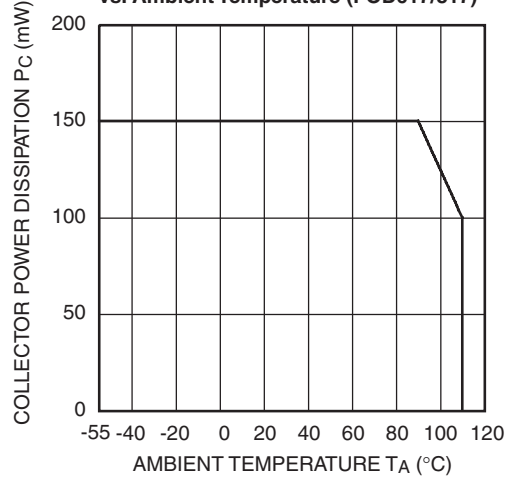


Fig. 3 Collector-Emitter Saturation Voltage vs. Forward Current

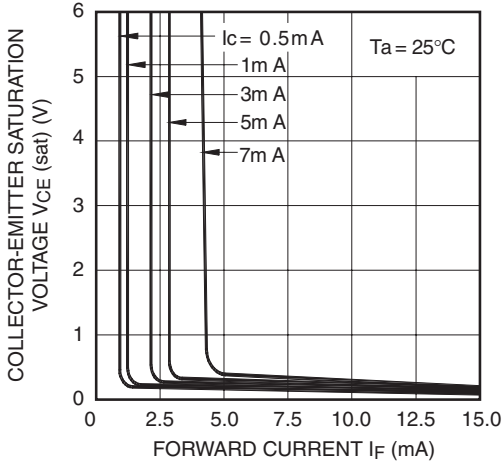


Fig. 4 Forward Current vs. Forward Voltage (FOD814)

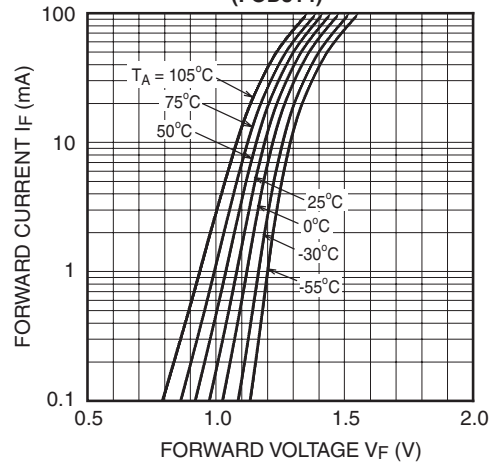


Fig. 5 Forward Current vs. Forward Voltage (FOD617/817)

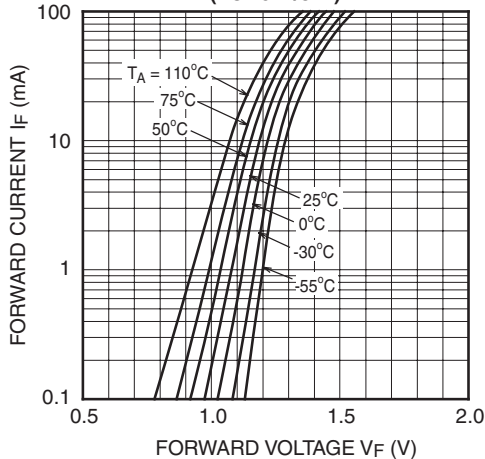
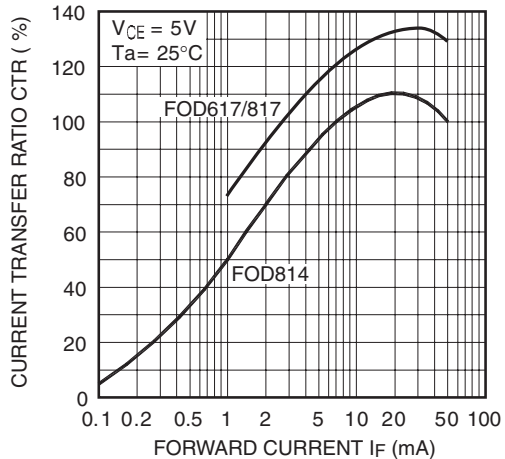


Fig. 6 Current Transfer Ratio vs. Forward Current



Typical Electrical/Optical Characteristics (Continued) ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Fig. 7 Collector Current vs. Collector-Emitter Voltage (FOD814)

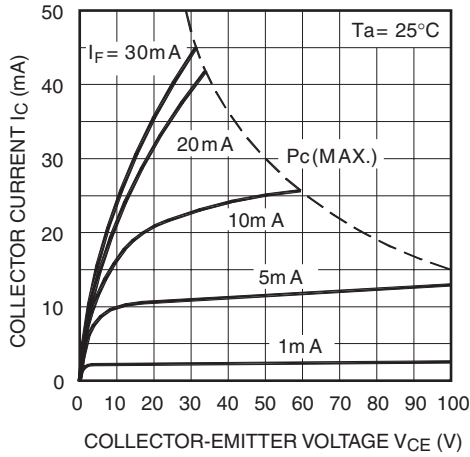


Fig. 8 Collector Current vs. Collector-Emitter Voltage (FOD617/817)

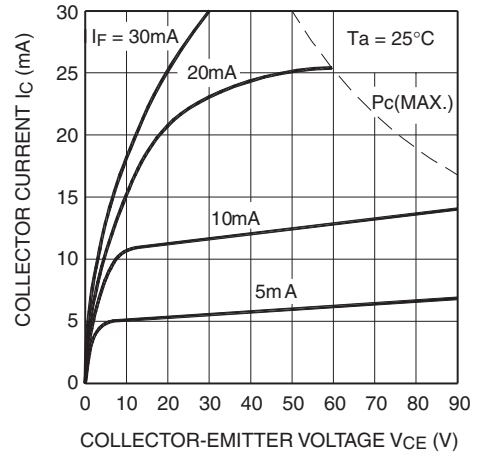


Fig. 9 Relative Current Transfer Ratio vs. Ambient Temperature

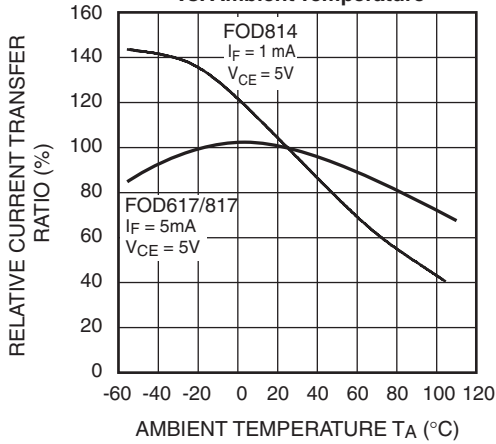


Fig. 10 Collector-Emitter Saturation Voltage vs. Ambient Temperature

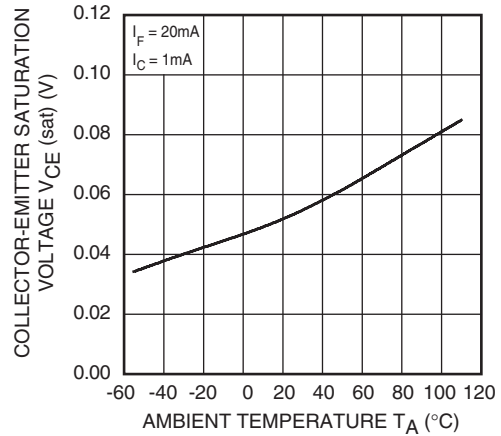


Fig. 11 LED Power Dissipation vs. Ambient Temperature (FOD814)

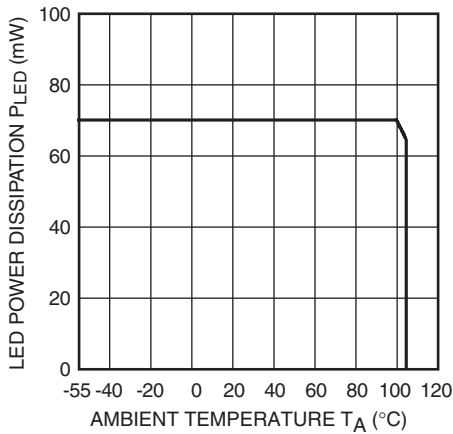
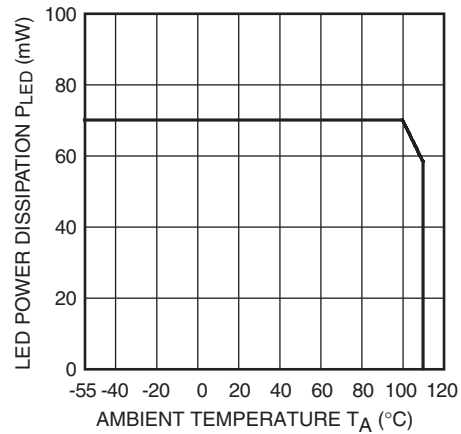


Fig. 12 LED Power Dissipation vs. Ambient Temperature (FOD617/817)



Typical Electrical/Optical Characteristics (Continued) ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Fig. 13 Response Time vs. Load Resistance

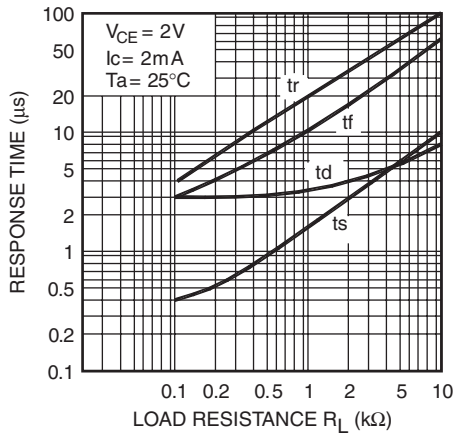


Fig. 14 Frequency Response

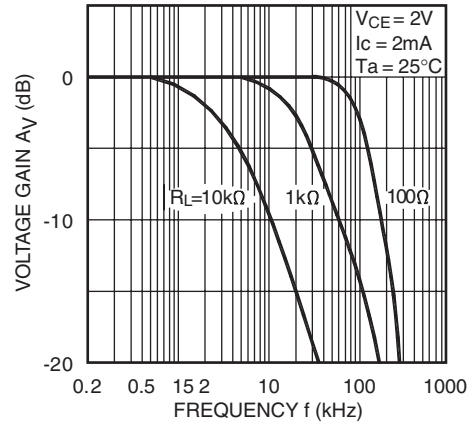
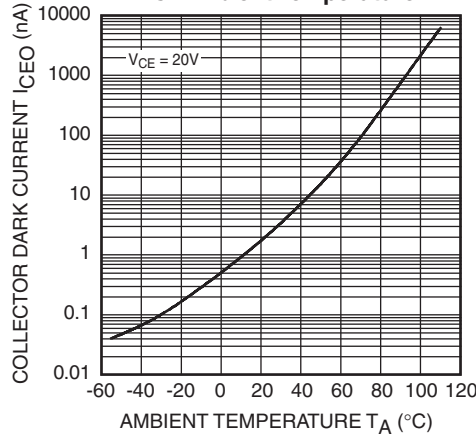
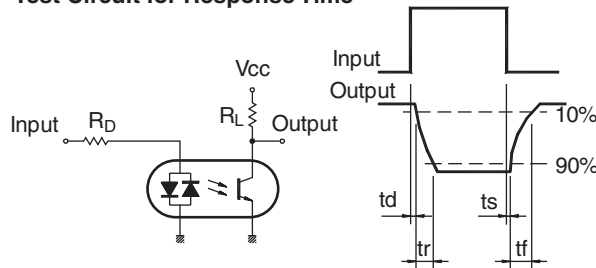


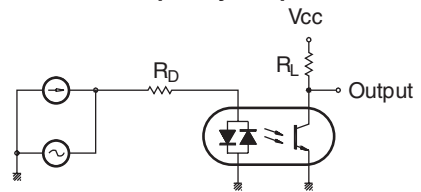
Fig. 15 Collector Dark Current vs. Ambient Temperature



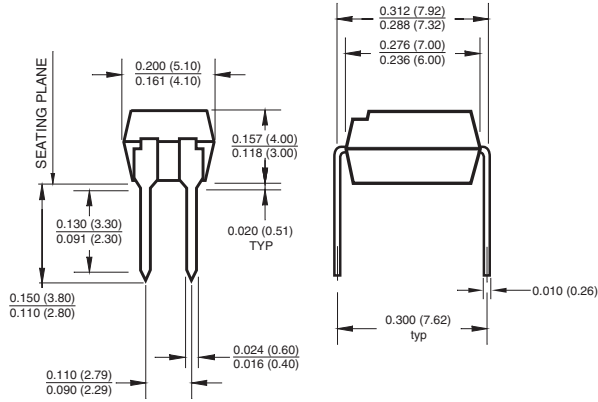
Test Circuit for Response Time



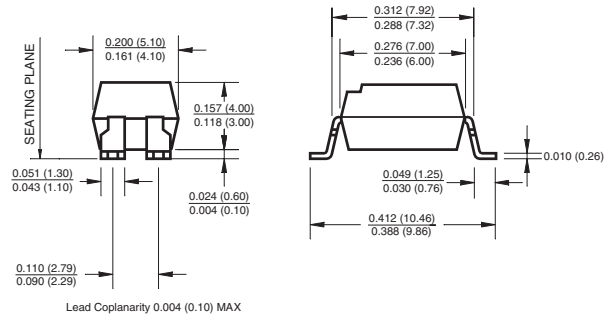
Test Circuit for Frequency Response



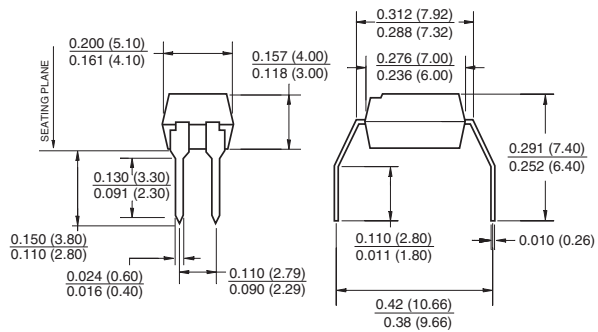
Package Dimensions (Through Hole)



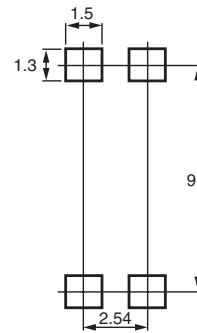
Package Dimensions (Surface Mount)



Package Dimensions (0.4" Lead Spacing)



Footprint Dimensions (Surface Mount)



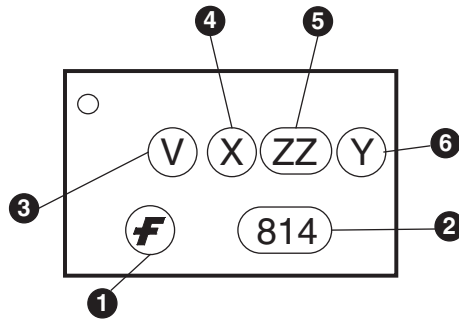
Note:

All dimensions are in inches (millimeters).

Ordering Information

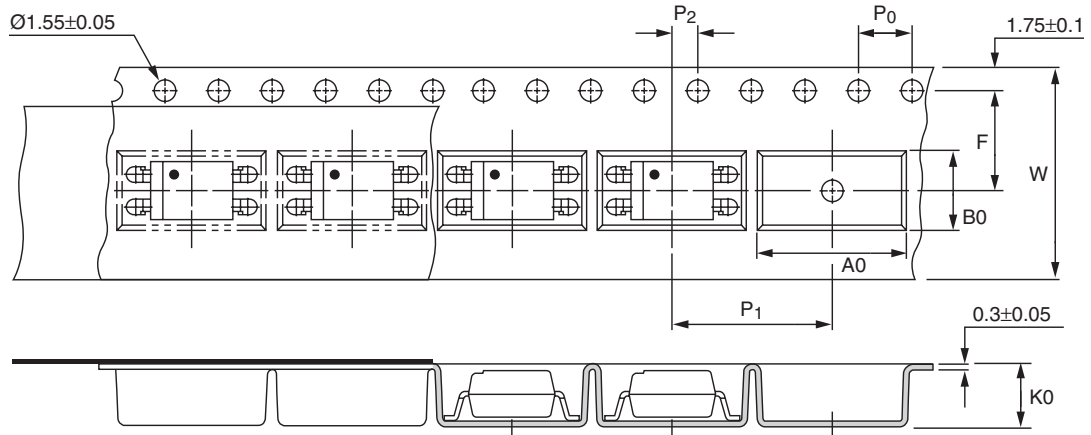
Option	Part Number Example	Description
S	FOD814S	Surface Mount Lead Bend
SD	FOD814SD	Surface Mount; Tape and reel
W	FOD814W	0.4" Lead Spacing
300	FOD814300	VDE Approved
300W	FOD814300W	VDE Approved, 0.4" Lead Spacing
3S	FOD8143S	VDE Approved, Surface Mount
3SD	FOD8143SD	VDE Approved, Surface Mount, Tape & Reel

Marking Information



Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

Carrier Tape Specifications

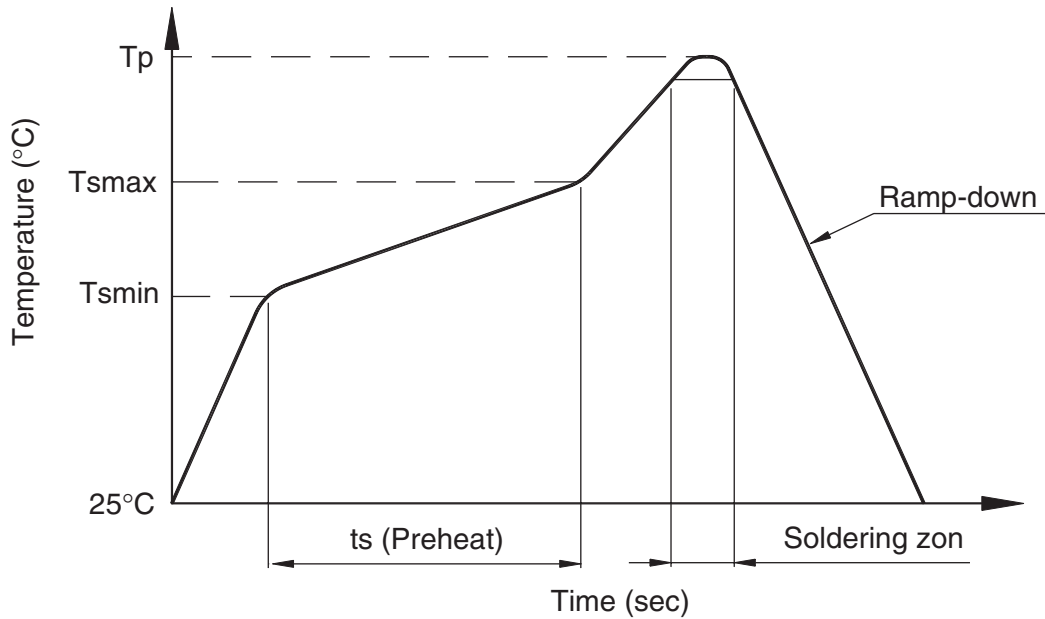


Note:

All dimensions are in millimeters.

Description	Symbol	Dimensions in mm (inches)
Tape wide	W	16 ± 0.3 (.63)
Pitch of sprocket holes	P_0	4 ± 0.1 (.15)
Distance of compartment	F	7.5 ± 0.1 (.295)
	P_2	2 ± 0.1 (.079)
Distance of compartment to compartment	P_1	12 ± 0.1 (.472)
Compartment	A_0	10.45 ± 0.1 (.411)
	B_0	5.30 ± 0.1 (.209)
	K_0	4.25 ± 0.1 (.167)

Lead Free Recommended IR Reflow Condition



Profile Feature	Pb-Sn solder assembly	Lead Free assembly
Preheat condition (T_{smin} - T_{smax} / t_s)	100°C ~ 150°C 60 ~ 120 sec	150°C ~ 200°C 60 ~ 120 sec
Melt soldering zone	183°C 60 ~ 120 sec	217°C 30 ~ 90 sec
Peak temperature (T_p)	240 +0/-5°C	260 +0/-5°C
Ramp-down rate	6°C/sec max.	6°C/sec max.

Recommended Wave Soldering condition

Profile Feature	For all solder assembly
Peak temperature (T_p)	Max 260°C for 10 sec

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

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